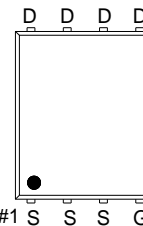
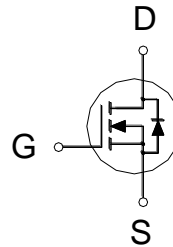




PRODUCT SUMMARY

| | | |
|---------------|--------------|-------|
| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D |
| 30V | 6.8mΩ | 54A |



G. GATE
D. DRAIN
S. SOURCE

100% UIS Tested
100% Rg Tested

Features

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

Applications

- Protection Circuits Applications.
- Computer for DC to DC Converters Applications.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|-----------------------|----------------|------------|-------|
| Drain-Source Voltage | | V_{DS} | 30 | V |
| Gate-Source Voltage | | V_{GS} | ±20 | V |
| Continuous Drain Current ⁴ | $T_C = 25\text{ °C}$ | I_D | 54 | A |
| | $T_C = 100\text{ °C}$ | | 34 | |
| Pulsed Drain Current ¹ | | I_{DM} | 140 | |
| Continuous Drain Current | $T_A = 25\text{ °C}$ | I_D | 16 | |
| | $T_A = 70\text{ °C}$ | | 13 | |
| Avalanche Current | | I_{AS} | 21 | |
| Avalanche Energy | $L = 0.1\text{mH}$ | E_{AS} | 22 | mJ |
| Power Dissipation | $T_C = 25\text{ °C}$ | P_D | 36 | W |
| | $T_C = 100\text{ °C}$ | | 14 | |
| Power Dissipation ³ | $T_A = 25\text{ °C}$ | P_D | 3.2 | W |
| | $T_A = 70\text{ °C}$ | | 2.1 | |
| Operating Junction & Storage Temperature Range | | T_j, T_{stg} | -55 to 150 | °C |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|--------------|-----------------|---------|---------|--------|
| Junction-to-Ambient ² | $t \leq 10s$ | $R_{\theta JA}$ | | 38 | °C / W |
| Junction-to-Ambient ² | Steady-State | $R_{\theta JA}$ | | 70 | |
| Junction-to-Case | Steady-State | $R_{\theta JC}$ | | 3.4 | |

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ C$.

³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10s$ value.

⁴The maximum current rating is package limited.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ C$, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT | |
|---|---------------------------------|--|---|------|-----------|------------|----|
| | | | MIN | TYP | MAX | | |
| STATIC | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 30 | | | V | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 1.3 | 1.7 | 2.3 | | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0V, V_{GS} = \pm 20V$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 24V, V_{GS} = 0V$ | | | 1 | μA | |
| | | $V_{DS} = 20V, V_{GS} = 0V, T_J = 55^\circ C$ | | | 10 | | |
| Drain-Source On-State Resistance ¹ | $R_{DS(on)}$ | $V_{GS} = 4.5V, I_D = 13A$ | | 7.4 | 10.2 | m Ω | |
| | | $V_{GS} = 10V, I_D = 13A$ | | 4.8 | 6.8 | | |
| Forward Transconductance ¹ | g_{fs} | $V_{DS} = 5V, I_D = 13A$ | | 62.5 | | S | |
| DYNAMIC | | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$ | | 887 | | pF | |
| Output Capacitance | C_{oss} | | | 489 | | | |
| Reverse Transfer Capacitance | C_{rss} | | | 37 | | | |
| Gate Resistance | R_g | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$ | | 2 | | Ω | |
| Total Gate Charge ² | Q_g | $V_{GS} = 10V$ | $V_{DS} = 15V, V_{GS} = 10V, I_D = 13A$ | 17.4 | | nC | |
| | | $V_{GS} = 4.5V$ | | 9.3 | | | |
| | Gate-Source Charge ² | Q_{gs} | | 2 | | | |
| Gate-Drain Charge ² | Q_{gd} | 4.4 | | | | | |
| Turn-On Delay Time ² | $t_{d(on)}$ | $V_{DS} = 15V, I_D \cong 13A, V_{GS} = 10V, R_{GEN} = 6\Omega$ | | | 12 | | nS |
| Rise Time ² | t_r | | | | 63 | | |
| Turn-Off Delay Time ² | $t_{d(off)}$ | | | 30 | | | |
| Fall Time ² | t_f | | | 58 | | | |

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)

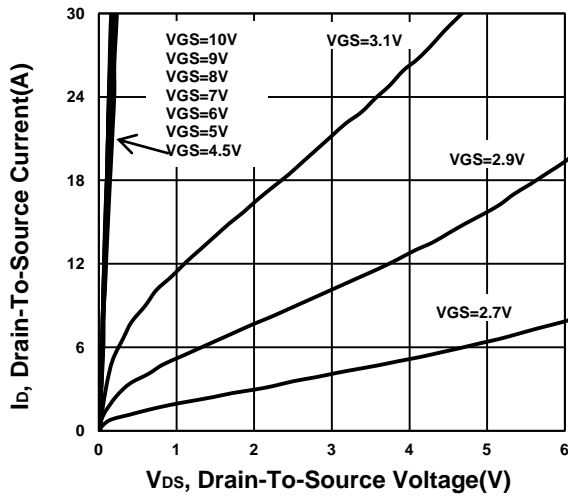
| | | | | | |
|---------------------------------|-----------------|---|--|------|----|
| Continuous Current ³ | I _S | | | 30 | A |
| Forward Voltage ¹ | V _{SD} | I _F = 13A, V _{GS} = 0V | | 1.2 | V |
| Reverse Recovery Time | t _{rr} | I _F = 13A, di _F /dt = 100A / μS | | 32 | nS |
| Reverse Recovery Charge | Q _{rr} | | | 17.5 | nC |

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

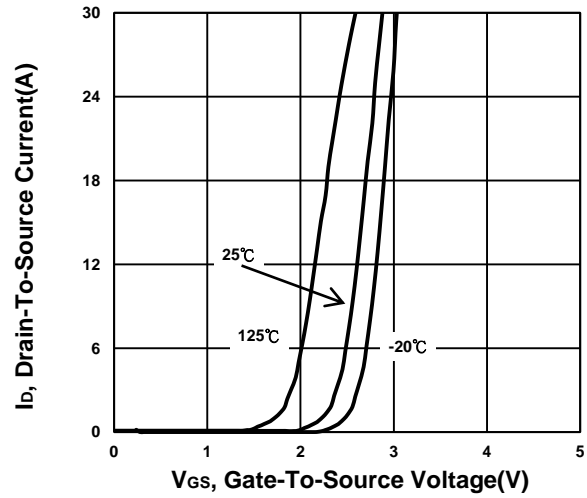
²Independent of operating temperature.

³The maximum current rating is package limited.

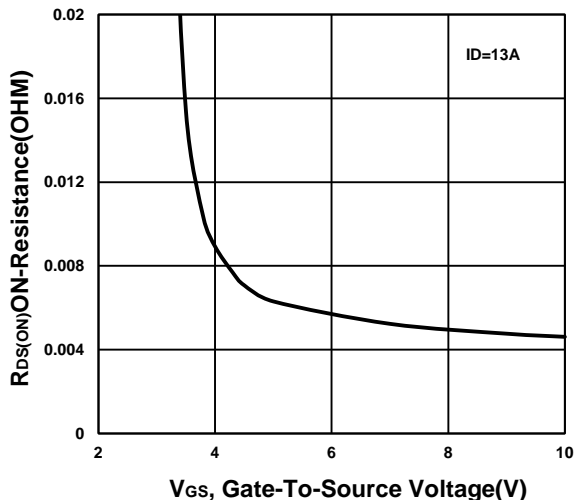
Output Characteristics



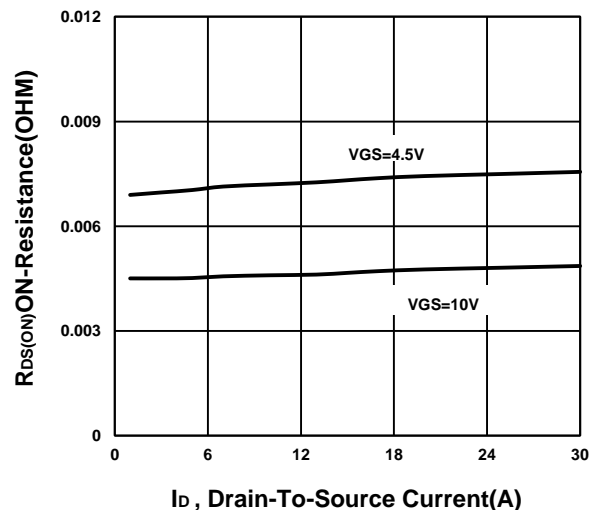
Transfer Characteristics



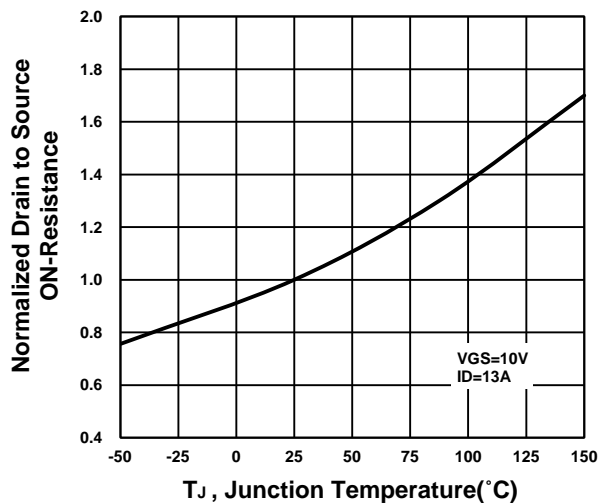
On-Resistance VS Gate-To-Source Voltage



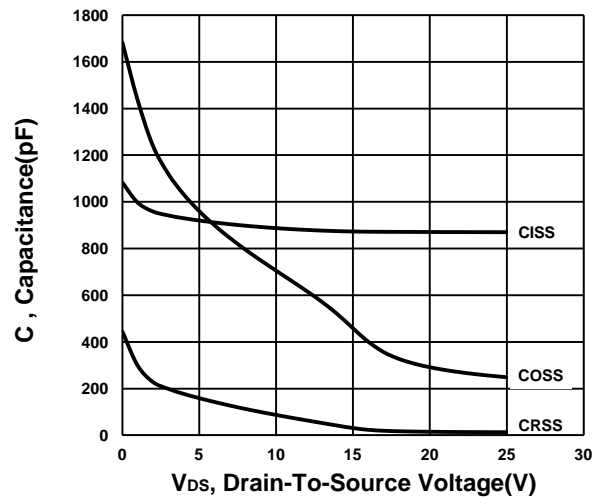
On-Resistance VS Drain Current



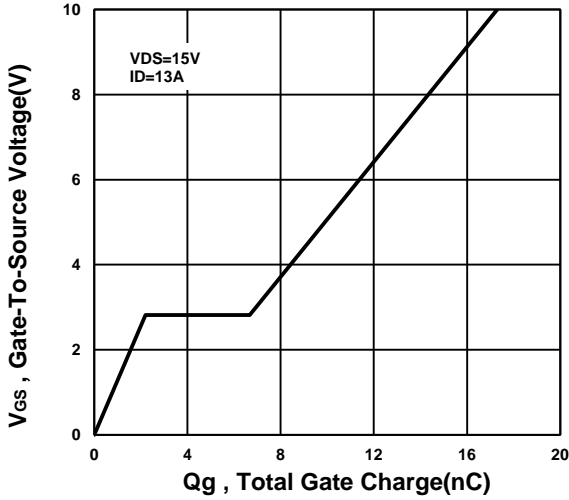
On-Resistance VS Temperature



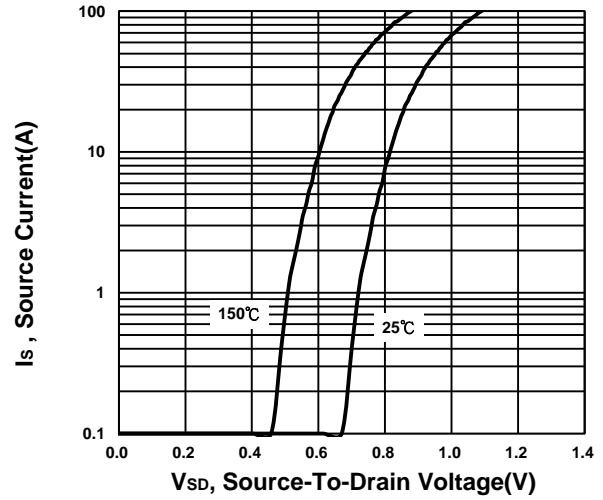
Capacitance Characteristic



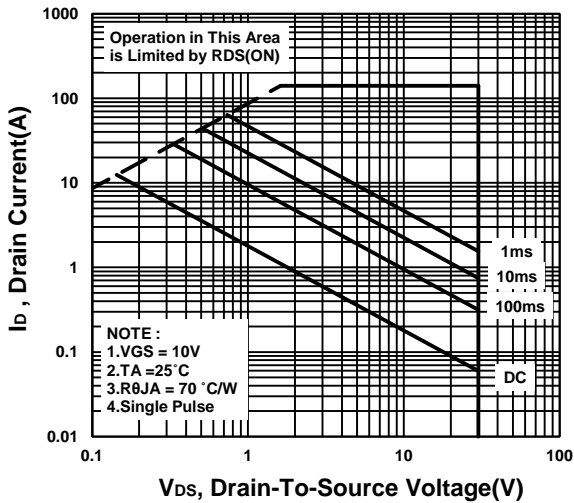
Gate charge Characteristics



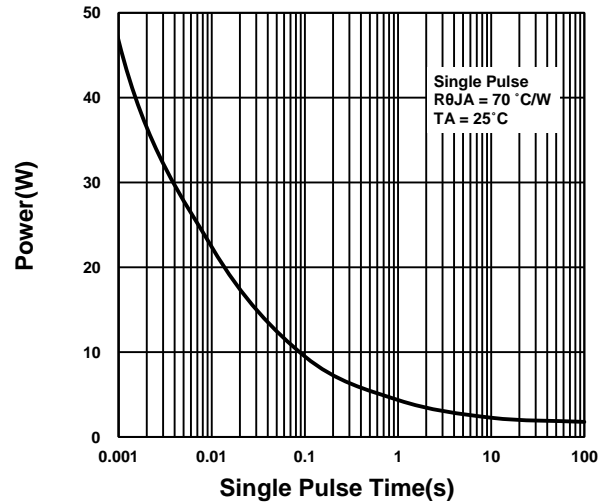
Source-Drain Diode Forward Voltage



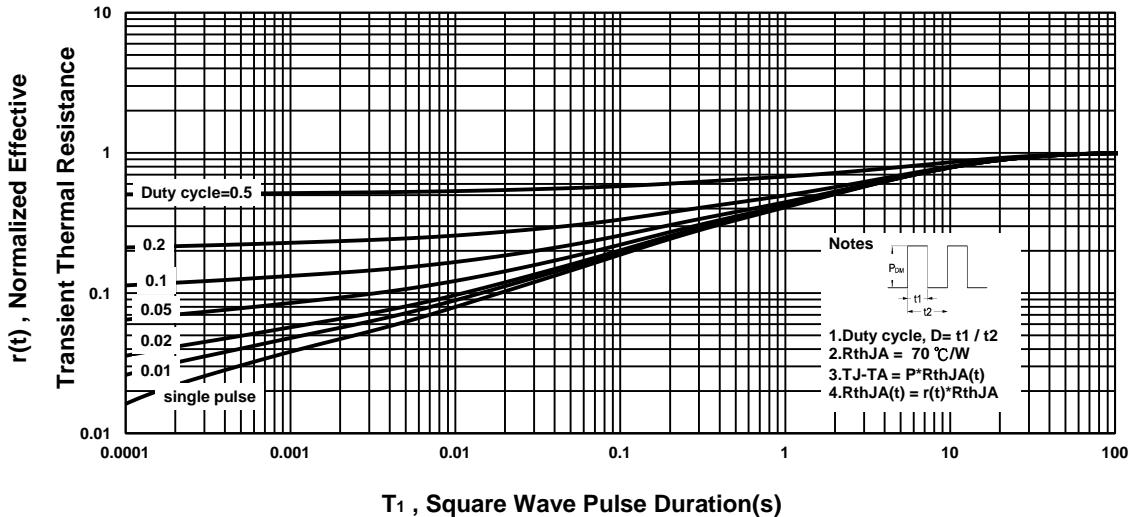
Safe Operating Area



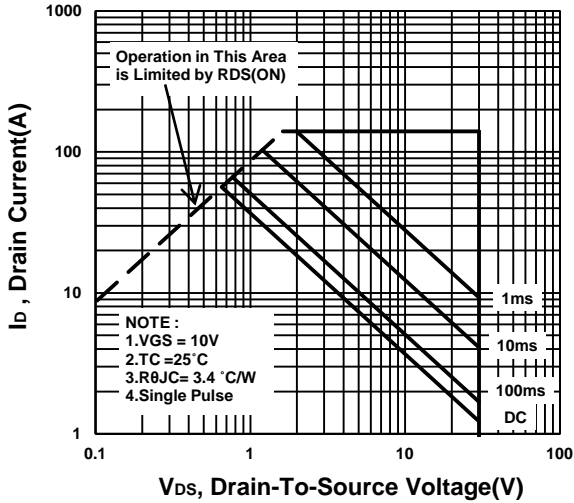
Single Pulse Maximum Power Dissipation



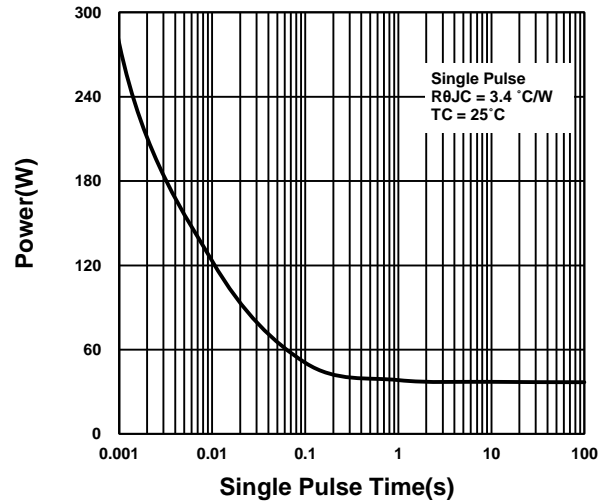
Transient Thermal Response Curve



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

